

Z-PACK | Z-PACK Future Bus+

TE Internal #: 5536623-1

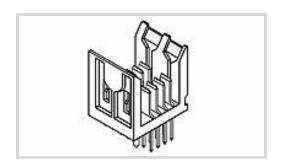
Rectangular Power Connectors, Header, Plug, Board-to-Board, 8 Position, 2 mm [.079 in] Centerline, Printed Circuit Board, UL 94V-0,

Z-PACK Future Bus+

View on TE.com >



Connectors > Power Connectors > Rectangular Power > Rectangular Power Connectors



Rectangular Power Connector Type: Header

Connector & Housing Type: Plug
Connector System: Board-to-Board

Number of Positions: 8

Centerline (Pitch): 2 mm [.079 in]

Features

Product Type Features

| Header Type | Partially Shrouded |
|-----------------------------------|-----------------------|
| Rectangular Power Connector Type | Header |
| Connector & Housing Type | Plug |
| Connector System | Board-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Number of Positions | 8 |
|----------------------------|----------|
| PCB Mount Orientation | Vertical |
| Number of Power Positions | 8 |
| Number of Signal Positions | 0 |
| Number of Rows | 4 |

Electrical Characteristics

| Insulation Resistance | 5000 MΩ |
|-----------------------|---------|
| Operating Voltage | 30 VDC |

Contact Features

| Mating Post Length | 8 mm[.315 in] |
|---|-------------------------------|
| PCB Contact Termination Area Plating Material Thickness | 3.81 – 8.89 μm[150 – 350 μin] |



| Contact Layout | Matrix |
|--|-------------------------------|
| Contact Mating Area Plating Material | Gold |
| Contact Base Material | Phosphor Bronze |
| Contact Current Rating (Max) | 5 A |
| Contact Retention Within Housing | With |
| Contact Type | Pin |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin] |
| Termination Features | |
| Termination Post & Tail Length | 3.43 mm[.135 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment Type | Polarizing Rib |
| PCB Mount Retention | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Centerline (Pitch) | 2 mm[.079 in] |
| Housing Color | Natural |
| Housing Material | LCP (Liquid Crystal Polymer) |
| Dimensions | |
| Connector Height | 17 mm[.668 in] |
| PCB Thickness (Recommended) | 1.6 mm[.063 in] |
| Row-to-Row Spacing | 2 mm[.079 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 125 °C[-67 – 257 °F] |
| Operation/Application | |
| Circuit Application | Power |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Glow Wire Rating | Standard Part - Not Glow Wire |
| Packaging Features | |
| Packaging Quantity | 48 |



| Packaging Method | Tube |
|------------------|------|
| | |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Pin-in-Paste capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Z-PACK Future Bus+





Backplane Connector Housings(19)



Hard Metric Backplane Connectors(1)



Rectangular Power Connectors(35)

Customers Also Bought



TE Part #1-292206-0 MINI CT SGL DIP H 10P NAT



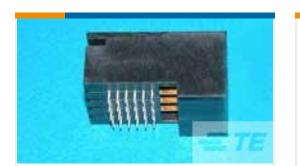
TE Part #3-352177-0 Z-PACK/M F-HDR 55+3



TE Part #103308-1 010 LOPRO HDR SP 15DP



TE Part #881545-1 SHUNT LP W/HANDLE 2POS 15AU



TE Part #1-1410271-8

MULTIGIG RT PWR .8" R/A HDR 4P



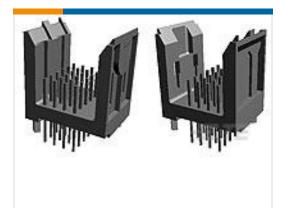
TE Part #2362764-5 MATENET, CABLE ASSY, 1 GBPS UTP



TE Part #2-747580-1 SHLDING FERRULE,PLTD TIN,BULK



TE Part #2169797-4 IMP,Power,3PR,R/A,Hdr,5.7,6.9Tin



TE Part #5536501-2 2MM FB,ASY,48,SIG,HDR,SL,4.25



2MM FB,ASY,24,SIG,HDR,SL,4.25

Documents

Product Drawings

2MMFB,ASY,008,PWR,HDR,SL,4.25

English

CAD Files

Customer View Model

ENG_CVM_5536623-1_O.3d_igs.zip

English

Customer View Model



ENG_CVM_5536623-1_O.3d_stp.zip

English

Customer View Model

ENG_CVM_5536623-1_O.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

POWER_CONNECTORS_CATALOG_SEC01_BOARD_TO_BOARD

English

Product Specifications

Application Specification

English